

SiC Schottky Barrier Diode

V_R	650V
I _F	4A
Q_{C}	11nC

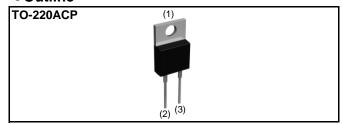
Features

- 1) Shorter recovery time
- 2) Reduced temperature dependence
- 3) High-speed switching possible
- 4) High surge current capability

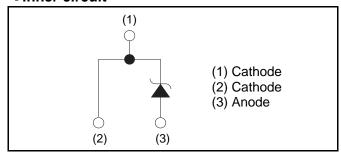
Construction

Silicon carbide epitaxial planar type

Outline



•Inner circuit



Packaging specifications

	ging opcomoditions	
	Packaging	Tube
	Reel size (mm)	-
Typo	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	50
	Packing code	C9
	Marking	SCS304AP

•Absolute maximum ratings $(T_i = 25^{\circ}C)$

Parameter		Symbol	Value	Unit
Reverse voltage (re	epetitive peak)	V_{RM}	650	V
Reverse voltage (D	C)	V_{R}	650	V
Continuous forward	current (T _c = 140°C)	I _F	4	А
Surge non-	PW=10ms sinusoidal, T _j =25°C		27	А
repetitive forward	PW=10ms sinusoidal, T _j =150°C	I _{FSM}	22	А
current	PW=10μs square, T _j =25°C	•	100	А
Repetitive peak forward current		I _{FRM}	20 *1	А
1≦PW≦10ms, T _j =25°C		$\int i^2 dt$	3.6	A ² s
i ² t value	1≦PW≦10ms, T _j =150°C	J rat	2.4	A ² s
Total power disspation		P_{D}	34 *2	W
Junction temperature		T _j	175	°C
Range of storage temperature		T _{stg}	-55 to +175	°C

^{*1} T_c=100°C, T_i=150°C, Duty cycle=10% *2 T_c=25°C

●Electrical characteristics (T_j = 25°C)

Parameter	Symbol	Conditions	Values			Linit
			Min.	Тур.	Max.	Unit
DC blocking voltage	V_{DC}	I _R =20μA	650	-	-	V
		I _F =4A,T _j =25°C	-	1.35	1.50	V
Forward voltage		I _F =4A,T _j =150°C	-	1.44	1.71	V
		I _F =4A,T _j =175°C	-	1.50	-	V
Reverse current	I _R	V _R =650V,T _j =25°C	-	0.012	20	μΑ
		V _R =650V,T _j =150°C	-	0.8	80	μΑ
		V _R =650V,T _j =175°C	-	2.4	-	μΑ
Total capacitance	С	V _R =1V,f=1MHz	-	200	-	pF
		V _R =650V,f=1MHz	-	18	-	pF
Total capacitive charge	Q_{C}	V _R =400V,di/dt=350A/μs	-	11	-	nC
Switching time	t _C	V _R =400V,di/dt=350A/μs	-	14	-	ns
Non-repetetive Avaranche Energy	E _{ava}	L=1mH	-	48	1	mJ

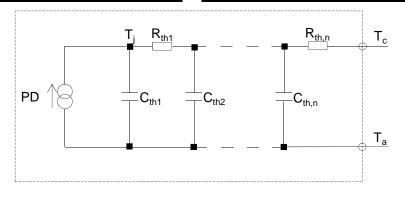
●Thermal characteristics

Parameter	Symbol	Conditions	Values			Unit
			Min.	Тур.	Max.	Offic
Thermal resistance	R _{th(j-c)}	-	-	3.0	4.4	°C/W

● Typical Transient Thermal Characteristics

Symbol	Value	Unit
R _{th1}	3.91E-02	
R _{th2}	3.76E-01	K/W
R _{th3}	2.54E+00	

Symbol	Value	Unit
C _{th1}	1.01E-04	
C _{th2}	4.02E-04	Ws/K
C _{th3}	1.19E-03	



• Electrical characteristic curves

Fig.1 V_F - I_F Characteristics

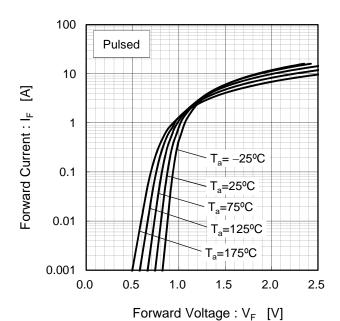
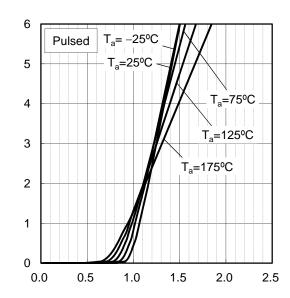


Fig.2 V_F - I_F Characteristics

Forward Current : IF [A]



Forward Voltage : V_F [V]

Fig.3 V_R - I_R Characteristics

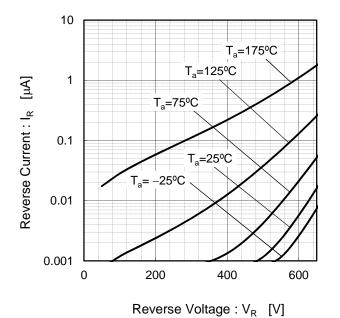
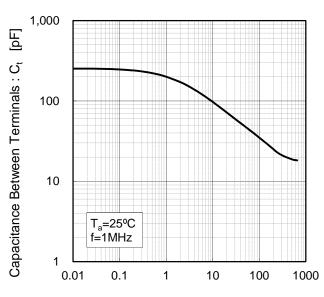


Fig.4 V_R-C_t Characteristics



Reverse Voltage : V_R [V]

• Electrical characteristic curves

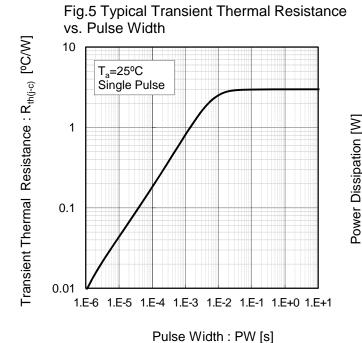
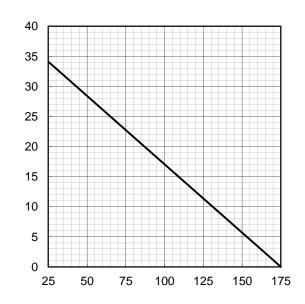


Fig.6 Power Dissipation



Case Temperature : T_c [°C]

Fig.7*3 Maximum peak forward current derating curve $I_P - T_c$

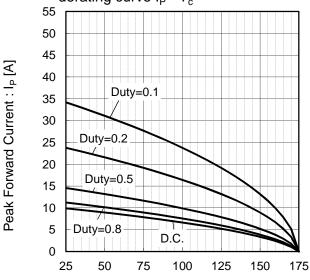
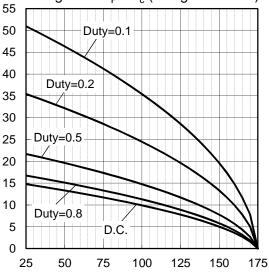


Fig.8*4 Typical peak forward current derating curve I_P - T_c (Not guaranteed)



Case Temperature : T_c [°C]

*4 Based on typ Vf, typ R_{th(j-c)} Typical value, not guaranteed Valid for switching of above 10kHz, excluding D.C. curve

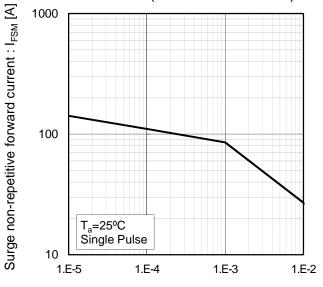
Case Temperature : T_c [°C] 3 Based on max Vf, max $R_{th(i-c)}$

*3 Based on max Vf, max R_{th(j-c)} Valid for switching of above 10kHz, excluding D.C. curve.

Peak Forward Current: Ip [A]

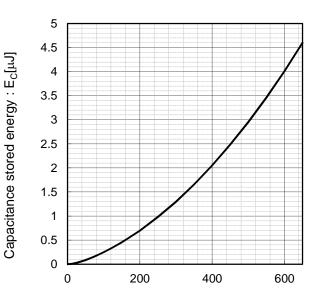
• Electrical characteristic curves

Fig.9 Surge non-repetitive forward current vs. Pulse width (Sinusoidal waveform)



Pulse Width: PW [s]

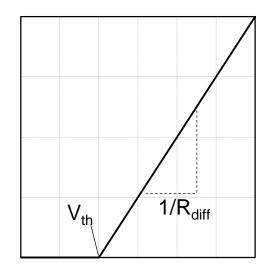
Fig.10 Typical capacitance store energy



Reverse Voltage: V_R [V]

Symplified forward characteristic model

Fig.11 Equivalent forward current curve



Forward Voltage: V_F

$$V_F = V_{th} + R_{diff} I_F$$

$$V_{th} (T_j) = a_0 + a_1 T_j$$

 $R_{diff} (T_j) = b_0 + b_1 T_j + b_2 T_j^2$

Symbol	Typical Value	Unit
a_0	9.66E-01	V
a ₁	-1.10E-0.3	V/°C
b ₀	8.80E-02	Ω
b ₁	1.87E-04	Ω/°C
b ₂	1.92E-06	$\Omega/^{\circ}C^{2}$

 T_i in °C; -55 °C < T_i <175 °C ; I_F <8 A

Forward Current: IF

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